X2QFN32 2.85x4.5, 0.4P CASE 722AF ISSUE B

1 SCALE 2:1

DATE 15 JAN 2020

## GENERIC MARKING DIAGRAM\*

- XXXX = Specific Device Code A = Assembly Location L = Wafer Lot
- Y = Year
- W = Work Week
- = Pb-Free Package .

\*This information is generic. Please refer to device data sheet for actual part marking. Pb–Free indicator, "G", may MARKIG1.159TDindLocation